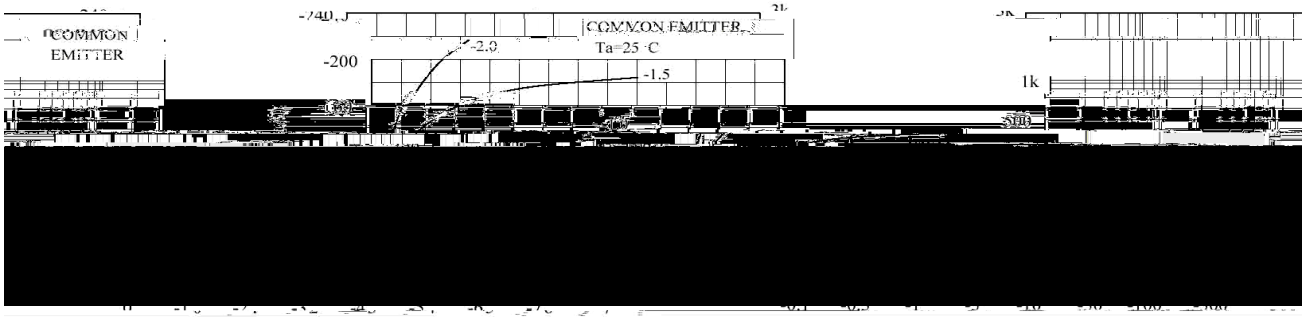
/ Electrical Characteristic Curve

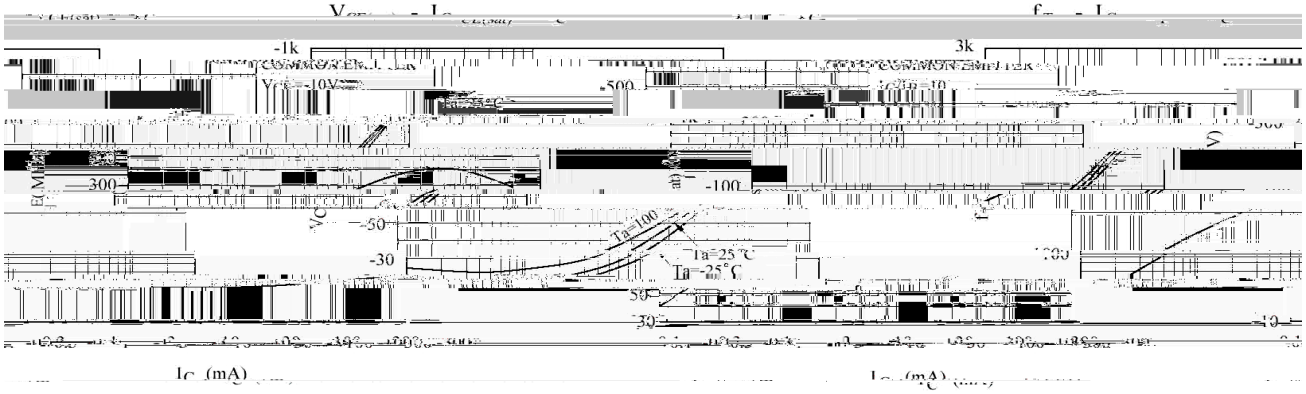
I_C - V_{CE}



V_{CE} (V)

h_{FE} - I_C

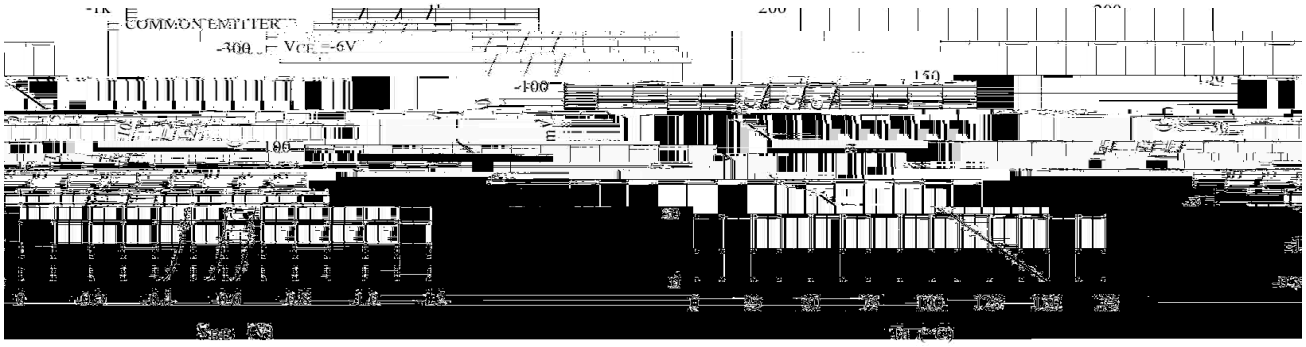
I_C (mA)



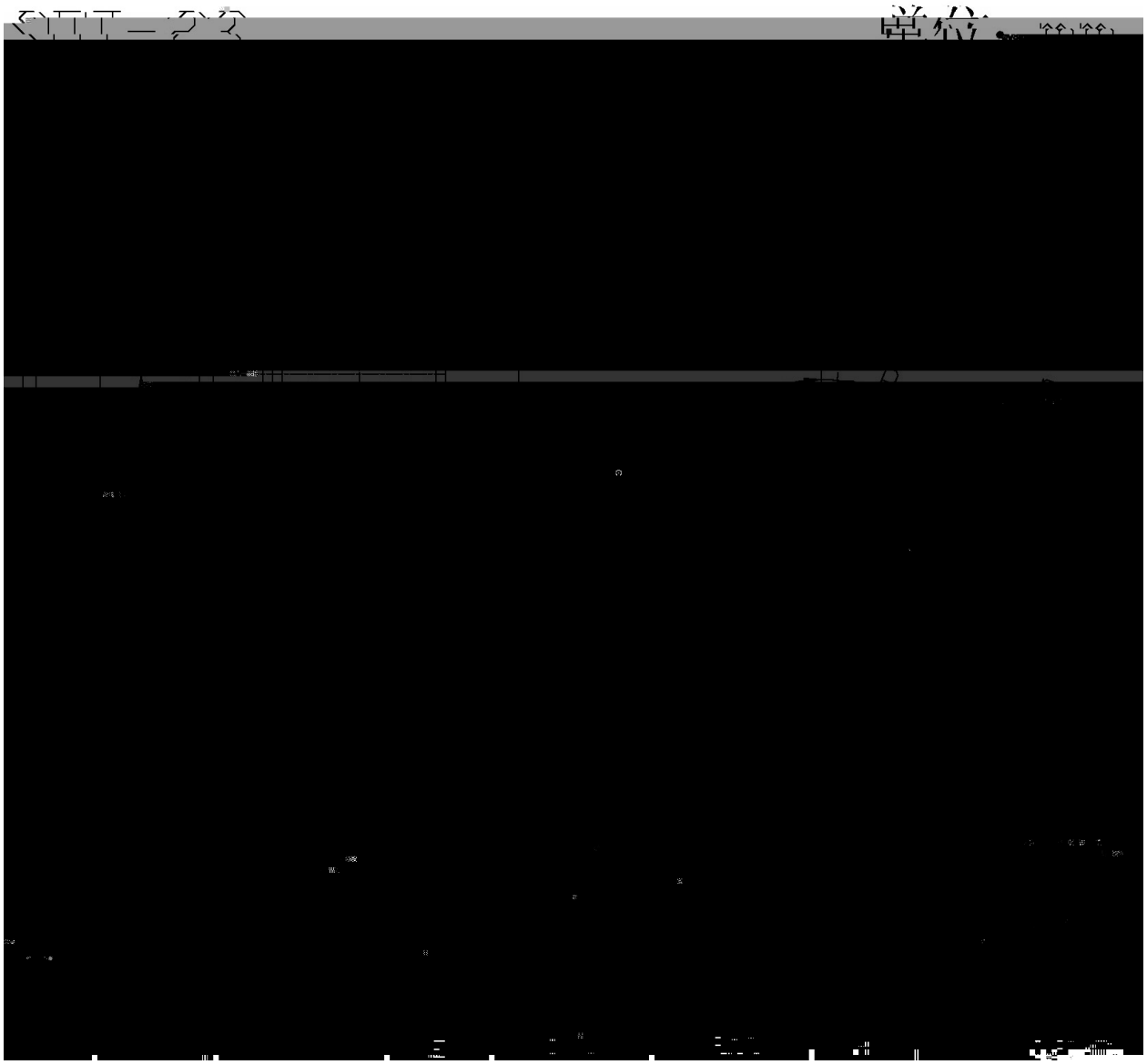
I_C (mA)

P_C - Ta

I_B - V_{BE}



/ Package Dimensions



/ Marking Instructions



H

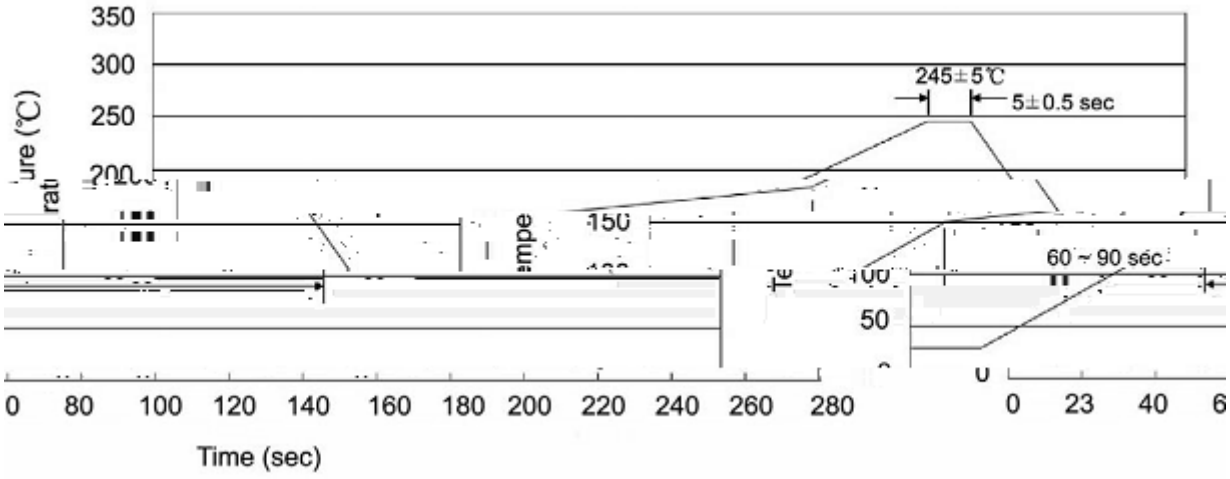
AS

O h_{FE}

Note:

H	Company Code
AS	Product Type
O	h_{FE} Classifications Symbol

( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)



				Note:	
1	25	150	60 90sec;	1.Preheating:25~150	, Time:60~90sec.
2	245±5		5±0.5sec;	2.Peak Temp.:245±5	, Duration:5±0.5sec.
3		2 10	/sec.	3. Cooling Speed: 2~10	/sec.

/ Resistance to Soldering Heat Test Conditions

260±5	10±1 sec.	Temp.:260±5	Time:10±1 sec

/ Packaging SPEC.

/ REEL

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm^3)		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱